INTERNATIONAL GEMOLOGICAL INSTITUTE

ELECTRONIC COPY

LABORATORY GROWN DIAMOND REPORT

March 23, 2024

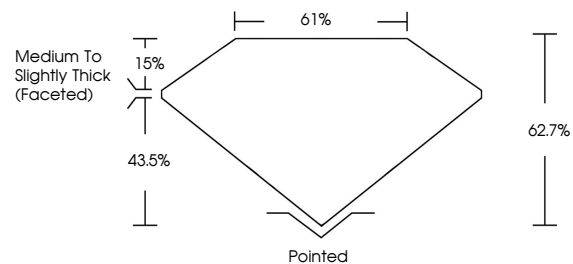|	
IGI Report Number	LG626423942
Description	LABORATORY GROWN DIAMOND
Shape and Cutting Style	OVAL BRILLIANT
Measurements	9.40 X 6.55 X 4.11 MM

GRADING RESULTS

Carat Weight	1.58 CARAT
Color Grade	D
Clarity Grade	VS 1
Cut Grade	EXCELLENT

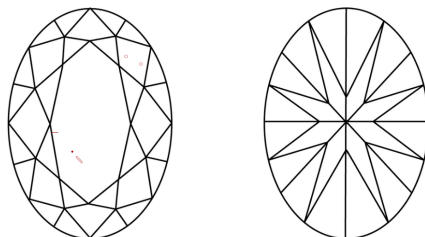**ADDITIONAL GRADING INFORMATION**

Polish	EXCELLENT
Symmetry	EXCELLENT
Fluorescence	NONE
Inscription(s)	IGI LG626423942

Comments: As Grown - No indication of post-growth treatment.
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.
Type II

LABORATORY GROWN DIAMOND REPORT

LG626423942

Report verification at igi.org

PROPORTIONS

Medium To Slightly Thick (Faceted)

61%
15%
43.5%
62.7%
Pointed

CLARITY CHARACTERISTICS

KEY TO SYMBOLS

Red symbols indicate internal characteristics.
Green symbols indicate external characteristics.

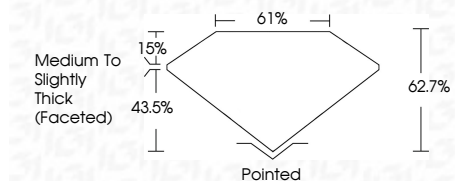**GRADING SCALES**

CLARITY

IF	VVS 1-2	VS 1-2	SI 1-2	I 1-3
Internally Flawless	Very Very Slightly Included	Very Slightly Included	Slightly Included	Included

COLOR

D	E	F	G	H	I	J	Faint	Very Light	Light

Sample Image Used

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www.igi.org

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